

SPECIFICATION FOR APPROVAL

() Preliminary Specification

(◆) Final Specification

Title	14.0"W HD+ TFT LCD
-------	--------------------

Customer	
MODEL	

SUPPLIER	LG Display Co., Ltd.
*MODEL	LP140WD1
Suffix	TLA1

*When you obtain standard approval,
please use the above model name without suffix

APPROVED BY	SIGNATURE
/	
/	
/	

Please return 1 copy for your confirmation with your signature and comments.

APPROVED BY	SIGNATURE
G. J. Kwon / S.Manager	
REVIEWED BY	
S. R. Kim / Manager	
PREPARED BY	
D. G. Choi / Engineer	

Products Engineering Dept.
LG Display Co., Ltd

Product Specification

Contents

No	ITEM	Page
	COVER	1
	CONTENTS	2
	RECORD OF REVISIONS	3
1	GENERAL DESCRIPTION	4
2	ABSOLUTE MAXIMUM RATINGS	5
3	ELECTRICAL SPECIFICATIONS	
3-1	ELECTRICAL CHARACTERISTICS	6
3-2	INTERFACE CONNECTIONS	7
3-3	LVDS SIGNAL TIMING SPECIFICATION	8-9
3-3	SIGNAL TIMING SPECIFICATIONS	9
3-4	SIGNAL TIMING WAVEFORMS	10
3-5	COLOR INPUT DATA REFERENCE	11
3-6	POWER SEQUENCE	12
4	OPTICAL SPECIFICATIONS	13-15
5	MECHANICAL CHARACTERISTICS	16-22
6	RELIABILITY	23
7	INTERNATIONAL STANDARDS	
7-1	SAFETY	24
7-2	EMC	24
8	PACKING	
8-1	DESIGNATION OF LOT MARK	25
8-2	PACKING FORM	25
9	PRECAUTIONS	26-27
A	APPENDIX. Enhanced Extended Display Identification Data	28-30

RECORD OF REVISIONS

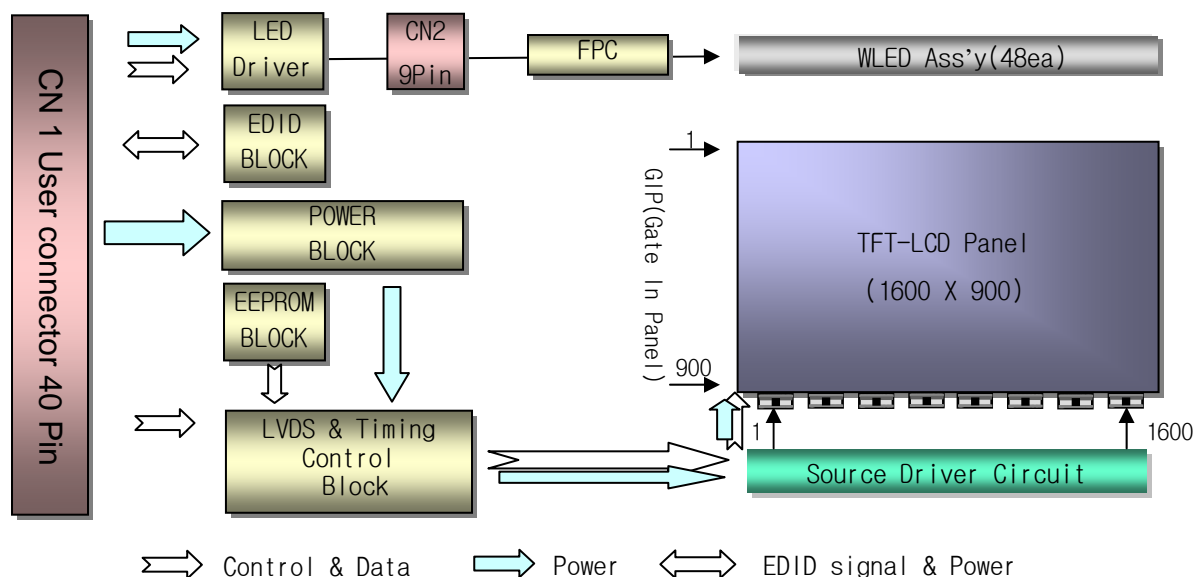
[illegible]

1. General Description

The LP140WD1 is a Color Active Matrix Liquid Crystal Display with an integral LED backlight system. The matrix employs a-Si Thin Film Transistor as the active element. It is a transmissive type display operating in the normally white mode. This TFT-LCD has 14.0 inches diagonally measured active display area with HD resolution (900 vertical by 1600 horizontal pixel array). Each pixel is divided into Red, Green and Blue sub-pixels or dots which are arranged in vertical stripes. Gray scale or the brightness of the sub-pixel color is determined with a 6-bit gray scale signal for each dot, thus, presenting a palette of more than 262,144 colors.

The LP140WD1 has been designed to apply the interface method that enables low power, high speed, low EMI.

The LP140WD1 is intended to support applications where thin thickness, low power are critical factors and graphic displays are important. In combination with the vertical arrangement of the sub-pixels, the LP140WD1 characteristics provide an excellent flat display for office automation products such as Notebook PC.



General Features

Active Screen Size	14.0 inches diagonal
Outline Dimension	323.5(H, typ) × 192.0(V, typ) × 5.4(D, max) [mm]
Pixel Pitch	0.1935mm × 0.1935 mm
Pixel Format	1600 horiz. By 900 vert. Pixels RGB strip arrangement
Color Depth	6-bit, 262,144 colors
Luminance, White	250 cd/m ² (Typ. 5 point)
Power Consumption	Total 5.0 Watt (Typ.) @ Logic input 1.45 Watt (Typ.), B/L input 3.56 Watt (Typ.)
Weight	380g (Max.)
Display Operating Mode	Transmissive mode, normally white
Surface Treatment	Glare treatment of the front polarizer
RoHS Comply	Yes

Product Specification

3. Electrical Specifications

3-1. Electrical Characteristics

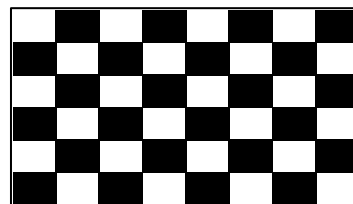
The LP140WD1 requires two power inputs. The first logic is employed to power the LCD electronics and to drive the TFT array and liquid crystal. The second backlight is the input about LED B/L with LED Driver.

Table 2. ELECTRICAL CHARACTERISTICS

Parameter	Symbol	Values			Unit	Notes
		Min	Typ	Max		
LOGIC :						
Power Supply Input Voltage	V _{CC}	3.0	3.3	3.6	V	
Power Supply Input Current	I _{CC}	-	440	510	mA	1
Power Consumption	P _{CC}	-	1.45	1.68	W	1
Power Supply Inrush Current	I _{CC_P}	-	-	2000	mA	
LVDS Impedance	Z _{LVDS}	90	100	110	Ω	2
BACKLIGHT : (with LED Driver)						
LED Power Input Voltage	V _{LED}	7.5	12.0	21.0	V	
LED Power Input Current	I _{LED}	-	20.0	21.0	mA	3
LED Power Consumption	P _{LED}	-	3.56	3.78	W	3
LED Power Inrush Current	I _{LED_P}	-	-	2000	mA	
PWM Dimming (Duty) Ratio	-	6	-	100	%	4
PWM Frequency	F _{PWM}	200	-	1000	Hz	5
PWM High Level Voltage	V _{PWM_H}	3.0	3.3	5.3	V	
PWM Low Level Voltage	V _{PWM_L}	0	-	0.5	V	
LED_EN High Voltage	V _{LED_EN_H}	3.0	3.3	5.3	V	
LED_EN Low Voltage	V _{LED_EN_L}	0	-	0.5	V	
Life Time		15,000	-	-	Hrs	6

Note)

1. The specified I_{CC} current and power consumption are under the V_{CC} = 3.3V , 25℃ , f_v = 60Hz condition whereas Mosaic pattern is displayed and f_v is the frame frequency.



2. This impedance value is needed to proper display and measured from LVDS Tx to the mating connector.
3. The specified LED current and power consumption are under the V_{LED} = 12.0V , 25℃ , Dimming of Max luminance whereas White pattern is displayed and f_v is the frame frequency.
4. The operation of LED Driver below minimum dimming ratio may cause flickering or reliability issue.
5. This Spec. is not effective at 100% dimming ratio as an exception because it has DC level equivalent to 0Hz. In spite of acceptable range as defined, the PWM Frequency should be fixed and stable for more consistent brightness control at any specific level desired.
6. The life time is determined as the time at which the typical brightness of LCD is 50% compare to that of initial value at the typical LED current. These LED backlight has 6 strings on it and the typical current of LED's string is base on 20mA.

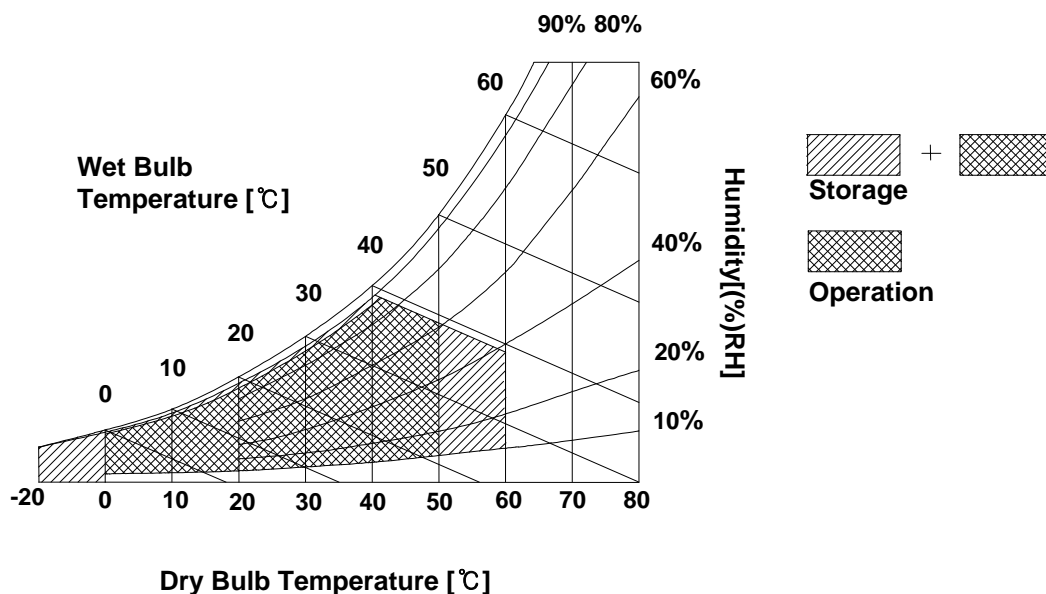
2. Absolute Maximum Ratings

The following are maximum values which, if exceeded, may cause faulty operation or damage to the unit.

Table 1. ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Values		Units	Notes
		Min	Max		
Power Input Voltage	VCC	-0.3	4.0	Vdc	at 25 ± 5°C
Operating Temperature	TOP	0	50	°C	1
Storage Temperature	HST	-20	60	°C	1
Operating Ambient Humidity	HOP	10	90	%RH	1
Storage Humidity	HST	10	90	%RH	1

Note : 1. Temperature and relative humidity range are shown in the figure below.
 Wet bulb temperature should be 39°C Max, and no condensation of water.



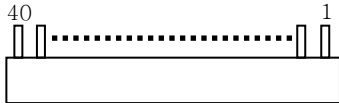
Product Specification

3-2. Interface Connections

This LCD employs two interface connections, a 40 pin connector is used for the module electronics interface and the other connector is used for the integral backlight system.

The electronics interface connector is a model CABLINE-VS RECE ASS'Y manufactured by I-PEX.

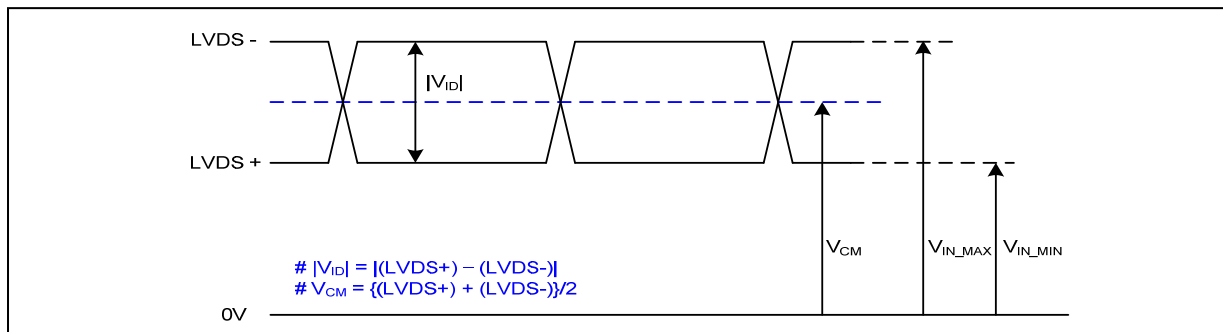
Table 3. MODULE CONNECTOR PIN CONFIGURATION (CN1)

Pin	Symbol	Description	Notes
1	NC	No Connection (Reserved for supplier)	1. Interface chips 1.1 LCD : SW, SW0617 (LCD Controller) including LVDS Receiver 1.2 System : THC63LVDF823A or equivalent * Pin to Pin compatible with LVDS
2	VCC	Power Supply, 3.3V Typ.	
3	VCC	Power Supply, 3.3V Typ.	
4	V EEDID	DDC 3.3V power	
5	TEST	Panel Self Test	
6	Clk EEDID	DDC Clock	
7	DATA EEDID	DDC Data	
8	Odd_R _{IN} 0-	Negative LVDS differential data input	
9	Odd_R _{IN} 0+	Positive LVDS differential data input	
10	GND	Ground	
11	Odd_R _{IN} 1-	Negative LVDS differential data input	2. Connector 2.1 LCD : CABLINE-VS(20455-040E-XX , I-PEX or its compatibles 2.2 Mating : CABLINE-VS PLUG CABLE ASS'Y or equivalent. 2.3 Connector pin arrangement
12	Odd_R _{IN} 1+	Positive LVDS differential data input	
13	GND	Ground	
14	Odd_R _{IN} 2-	Negative LVDS differential data input	
15	Odd_R _{IN} 2+	Positive LVDS differential data input	
16	GND	Ground	
17	Odd_CLKIN-	Negative LVDS differential clock input	
18	Odd_CLKIN+	Positive LVDS differential clock input	
19	GND	Ground	
20	Even_R _{IN} 0-	Negative LVDS differential data input	
21	Even_R _{IN} 0+	Positive LVDS differential data input	 <p style="text-align: center;">[LCD Module Rear View]</p>
22	GND	Ground	
23	Even_R _{IN} 1-	Negative LVDS differential data input	
24	Even_R _{IN} 1+	Positive LVDS differential data input	
25	GND	Ground	
26	Even_R _{IN} 2-	Negative LVDS differential data input	
27	Even_R _{IN} 2+	Positive LVDS differential data input	
28	GND	Ground	
29	Even_CLKIN-	Negative LVDS differential clock input	
30	Even_CLKIN+	Positive LVDS differential clock input	
31	VLED_GND	LED Ground	
32	VLED_GND	LED Ground	
33	VLED_GND	LED Ground	
34	NC	No Connection (Reserved)	
35	PWM	PWM for luminance control	
36	LED_EN	Backlight On/Off Control	
37	NC	No Connection (Reserved)	
38	VLED	LED Power Supply 7.5V-21V	
39	VLED	LED Power Supply 7.5V-21V	
40	VLED	LED Power Supply 7.5V-21V	

Product Specification

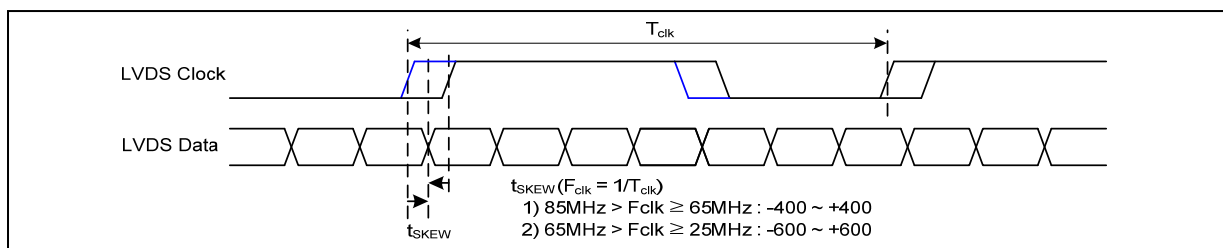
3-3. LVDS Signal Timing Specifications

3-3-1. DC Specification



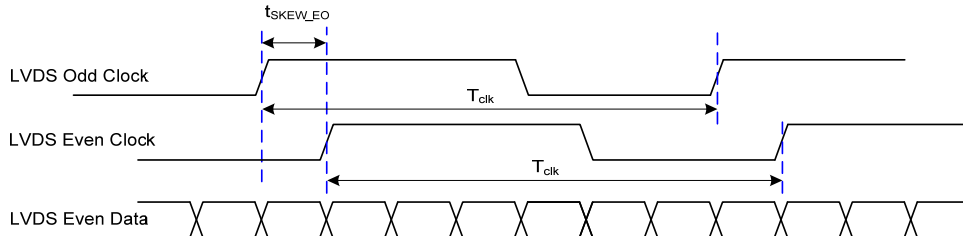
Description	Symbol	Min	Max	Unit	Notes
LVDS Differential Voltage	$ V_{ID} $	100	600	mV	-
LVDS Common mode Voltage	V_{CM}	0.6	1.8	V	-
LVDS Input Voltage Range	V_{IN}	0.3	2.1	V	-

3-3-2. AC Specification

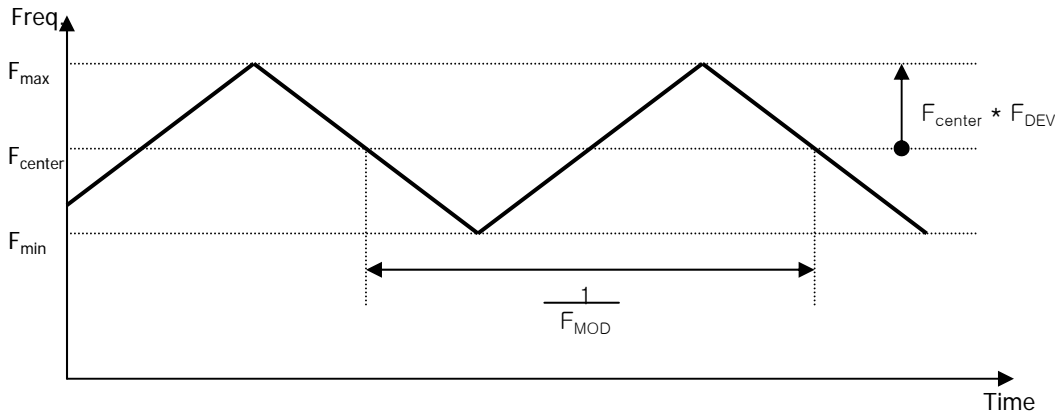


Description	Symbol	Min	Max	Unit	Notes
LVDS Clock to Data Skew Margin	t_{SKEW}	- 400	+ 400	ps	$85MHz > F_{clk} \geq 65MHz$
	t_{SKEW}	- 600	+ 600	ps	$65MHz > F_{clk} \geq 25MHz$
LVDS Clock to Clock Skew Margin (Even to Odd)	t_{SKEW_EO}	- 1/7	+ 1/7	T_{clk}	-
Maximum deviation of input clock frequency during SSC	F_{DEV}	-	± 3	%	-
Maximum modulation frequency of input clock during SSC	F_{MOD}	-	200	KHz	-

Product Specification



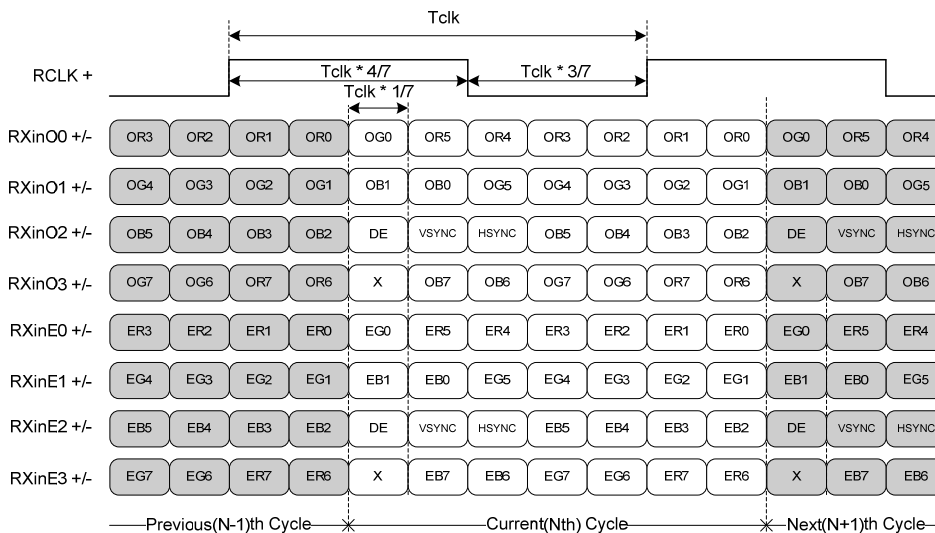
< Clock skew margin between channel >



< Spread Spectrum >

3-3-3. Data Format

1) LVDS 2 Port



MSB	R7
	R6
	R5
	R4
	R3
	R2
	R1
LSB	R0

* ODD = 1st Pixel
EVEN = 2nd Pixel

< LVDS Data Format >

3-4. Signal Timing Specifications

This is the signal timing required at the input of the User connector. All of the interface signal timing should be satisfied with the following specifications and specifications of LVDS Tx/Rx for its proper operation.

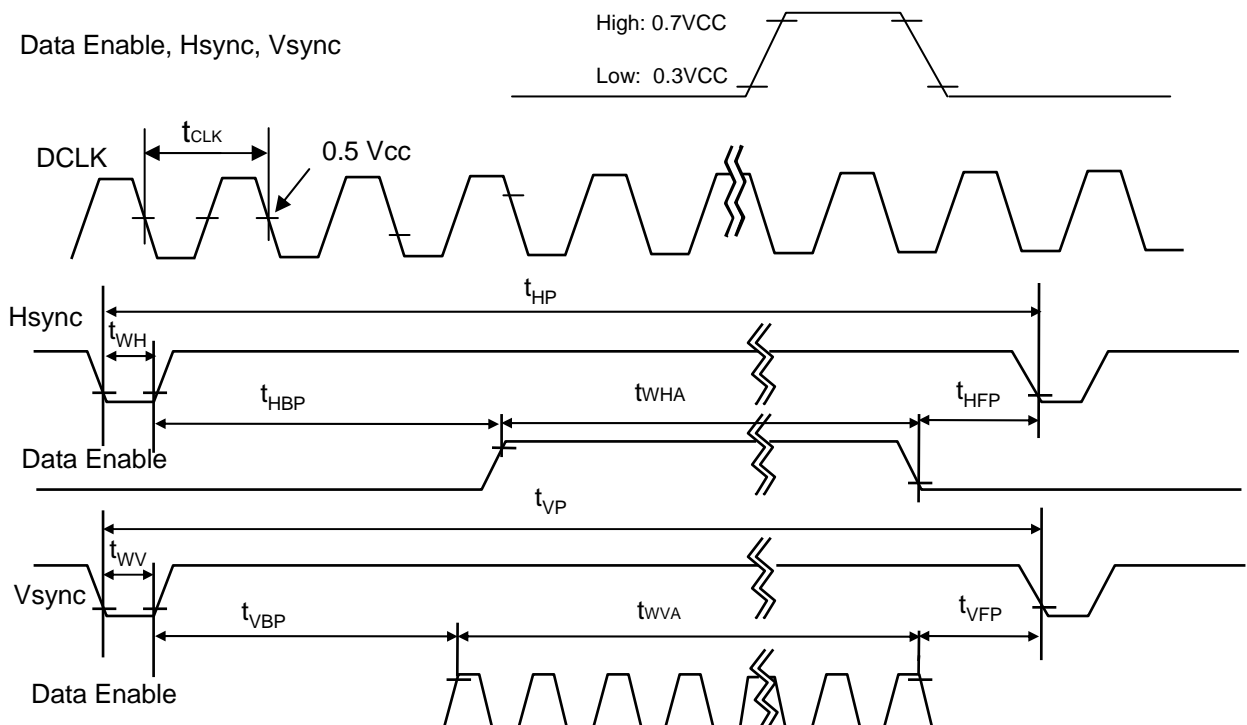
Table 4. TIMING TABLE

ITEM	Symbol	Min	Typ	Max	Unit	Note
DCLK	Frequency	f_{CLK}	47.61	50.67	53.35	MHz
Hsync	Period	t_{HP}	872	912	936	tCLK
	Width	t_{WH}	32	48	56	
	Width-Active	t_{WHA}	800	800	800	
Vsync	Period	t_{VP}	910	926	950	tHP
	Width	t_{WV}	3	5	8	
	Width-Active	t_{WVA}	900	900	900	
Data Enable	Horizontal back porch	t_{HBP}	24	32	40	tCLK
	Horizontal front porch	t_{HFP}	16	32	40	
	Vertical back porch	t_{VBP}	5	18	24	tHP
	Vertical front porch	t_{VFP}	2	3	18	

3-5. Signal Timing Waveforms

Condition : VCC = 3.3V

Data Enable, Hsync, Vsync



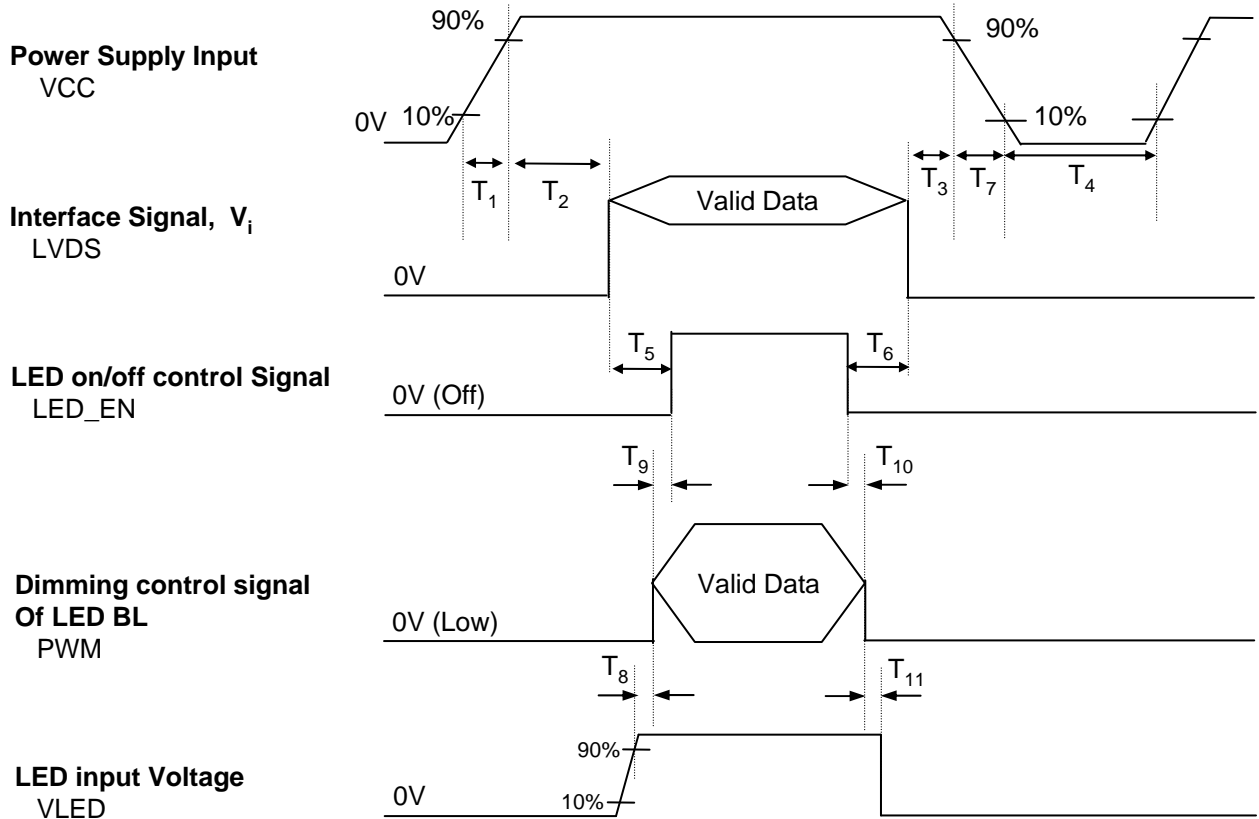
Product Specification
3-6. Color Input Data Reference

The brightness of each primary color (red, green and blue) is based on the 6-bit gray scale data input for the color ; the higher the binary input, the brighter the color. The table below provides a reference for color versus data input.

Table 5. COLOR DATA REFERENCE

Color		Input Color Data																	
		RED						GREEN						BLUE					
		MSB			LSB			MSB			LSB			MSB			LSB		
		R 5	R 4	R 3	R 2	R 1	R 0	G 5	G 4	G 3	G 2	G 1	G 0	B 5	B 4	B 3	B 2	B 1	B 0
Basic Color	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Green	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
	Blue	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
	Cyan	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	0	0	0	0	0	0	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
RED	RED (00)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	RED (01)	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0
	...																		
	RED (62)	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0
	RED (63)	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
GREEN	GREEN (00)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	GREEN (01)	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0
	...																		
	GREEN (62)	0	0	0	0	0	0	1	1	1	1	1	0	0	0	0	0	0	0
	GREEN (63)	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
BLUE	BLUE (00)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	BLUE (01)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
	...																		
	BLUE (62)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	0
	BLUE (63)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1

3-7. Power Sequence


Table 6. POWER SEQUENCE TABLE

Parameter	Value			Units
	Min.	Typ.	Max.	
T ₁	0.5	-	10	ms
T ₂	0	-	50	ms
T ₃	0	-	50	ms
T ₄	400	-	-	ms
T ₅	200	-	-	ms
T ₆	200	-	-	ms
T ₇	3	-	10	ms
T ₈	10	-	-	ms
T ₉	0	-	-	ms
T ₁₀	0	-	-	ms
T ₁₁	10	-	-	ms

Note)

1. Valid Data is Data to meet "3-3. LVDS Signal Timing Specifications"
2. Please avoid floating state of interface signal at invalid period.
3. When the interface signal is invalid, be sure to pull down the power supply for LCD VCC to 0V.
4. LED power must be turn on after power supply for LCD and interface signal are valid.

4. Optical Specification

Optical characteristics are determined after the unit has been 'ON' and stable for approximately 30 minutes in a dark environment at 25°C. The values specified are at an approximate distance 50cm from the LCD surface at a viewing angle of Φ and Θ equal to 0°.

FIG. 1 presents additional information concerning the measurement equipment and method.

FIG. 1 Optical Characteristic Measurement Equipment and Method

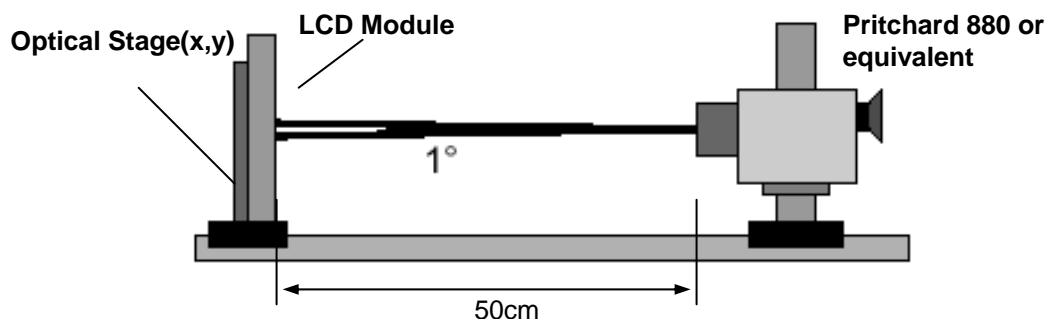


Table 7. OPTICAL CHARACTERISTICS

Ta=25°C, VCC=3.3V, fv=60Hz, fCLK= 50.67MHz, ILED= 20 mA

Parameter	Symbol	Values			Units	Notes
		Min	Typ	Max		
Contrast Ratio	CR	500	-	-		1
Surface Luminance, white	L _{WH}	230	250	-	cd/m ²	2
Luminance Variation	δ_{WHITE}	-	-	1.6		3
Response Time	T _R + T _{RD}	-	8	-	ms	4
Color Coordinates						
RED	RX	0.574	0.604	0.634		
	RY	0.326	0.356	0.386		
GREEN	GX	0.296	0.326	0.356		
	GY	0.551	0.581	0.611		
BLUE	BX	0.119	0.149	0.179		
	BY	0.023	0.053	0.083		
WHITE	WX	0.283	0.313	0.343		
	WY	0.299	0.329	0.359		
Viewing Angle						
x axis, right($\Phi=0^\circ$)	Θ_r	60	-	-	degree	5
x axis, left ($\Phi=180^\circ$)	Θ_l	60	-	-	degree	
y axis, up ($\Phi=90^\circ$)	Θ_u	50	-	-	degree	
y axis, down ($\Phi=270^\circ$)	Θ_d	50	-	-	degree	
Gray Scale						6

Product Specification

Note)

1. Contrast Ratio(CR) is defined mathematically as

$$\text{Contrast Ratio} = \frac{\text{Surface Luminance with all white pixels}}{\text{Surface Luminance with all black pixels}}$$

2. Surface luminance is the average of 5 point across the LCD surface 50cm from the surface with all pixels displaying white. For more information see FIG 1.

$$L_{WH} = \text{Average}(L_1, L_2, \dots L_5)$$

3. The variation in surface luminance , The panel total variation (δ_{WHITE}) is determined by measuring L_N at each test position 1 through 13 and then defined as followed numerical formula.

For more information see FIG 2.

$$\delta_{WHITE} = \frac{\text{Maximum}(L_1, L_2, \dots L_{13})}{\text{Minimum}(L_1, L_2, \dots L_{13})}$$

4. Response time is the time required for the display to transition from white to black (rise time, Tr_R) and from black to white(Decay Time, Tr_D). For additional information see FIG 3.

5. Viewing angle is the angle at which the contrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 4.

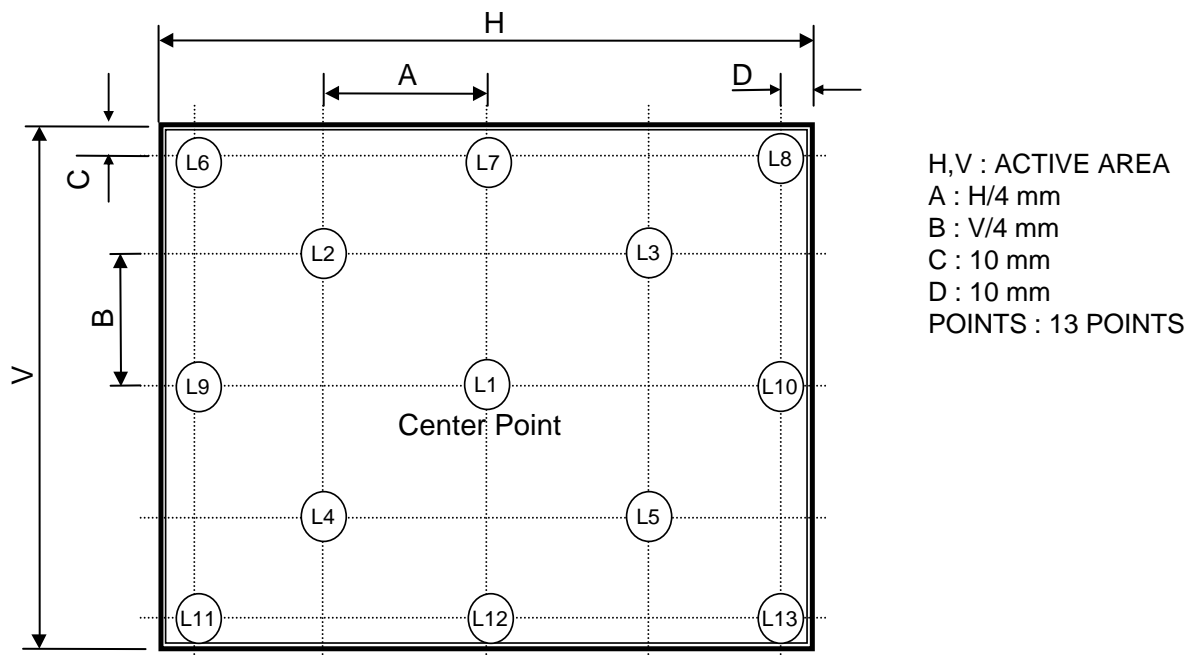
6. Gray scale specification

* $f_V = 60\text{Hz}$

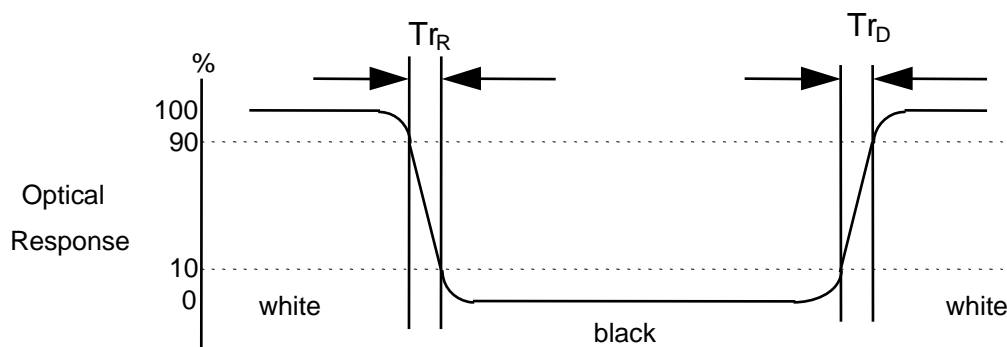
Gray Level	Luminance [%] (Typ)
L0	0.00
L7	1.00
L15	4.25
L23	10.9
L31	21.0
L39	34.8
L47	52.5
L55	74.2
L63	100

FIG. 2 Luminance

<measuring point for surface luminance & measuring point for luminance variation>


FIG. 3 Response Time

The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white".



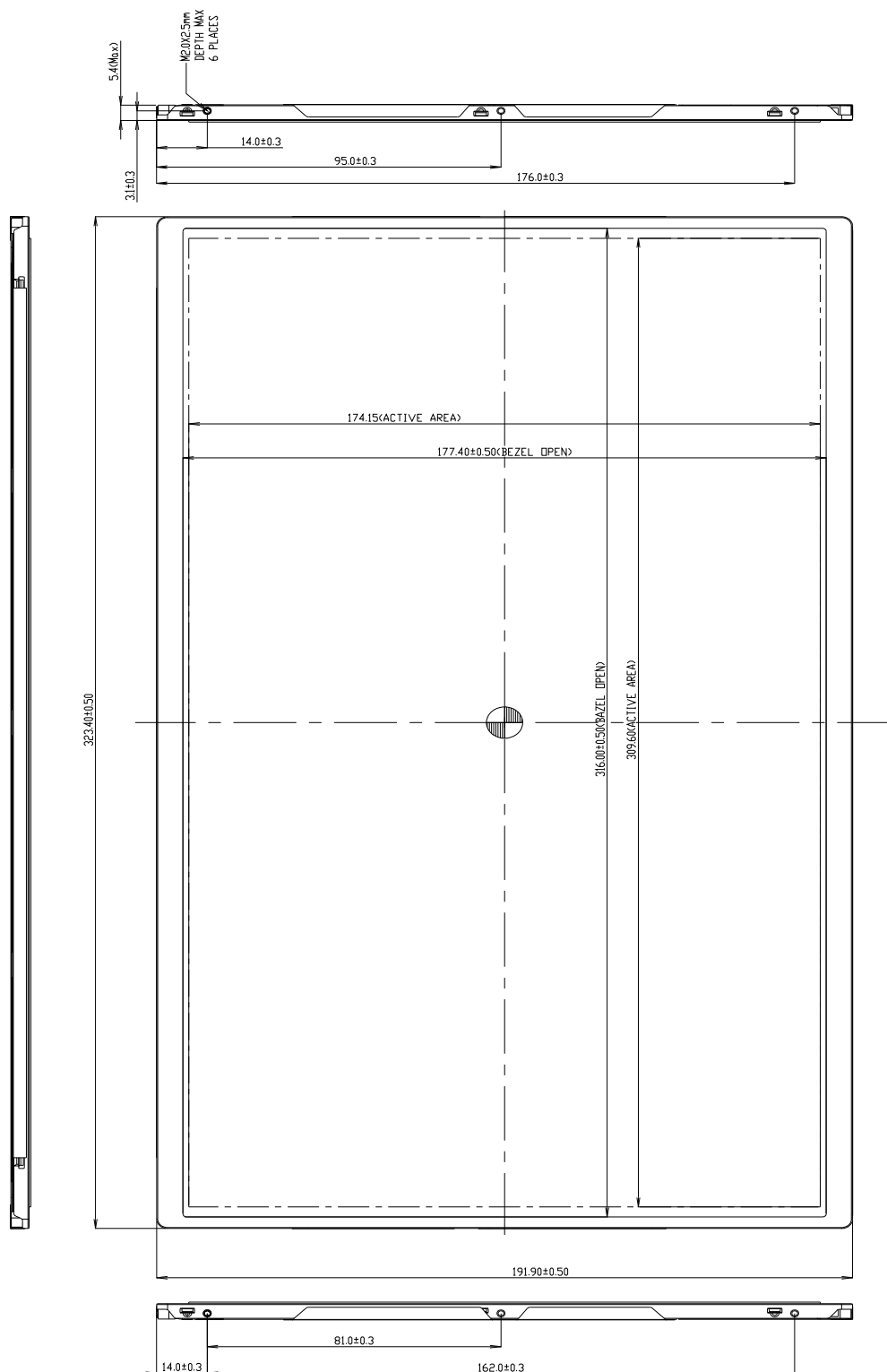
Product Specification

5. Mechanical Characteristics

The contents provide general mechanical characteristics for the model LP140WD1. In addition the figures in the next page are detailed mechanical drawing of the LCD.

Outline Dimension	Horizontal	$323.5 \pm 0.5\text{mm}$
	Vertical	$192.0 \pm 0.5\text{mm}$
	Thickness	5.4mm (max)
Bezel Area	Horizontal (VESA Standard)	$316.0 \pm 0.5\text{mm}$
	Vertical (VESA Standard)	$177.4 \pm 0.5\text{mm}$
Active Display Area	Horizontal	309.60 mm
	Vertical	174.15 mm
Weight	380g (Max.)	
Surface Treatment	Glare treatment of the front polarizer	

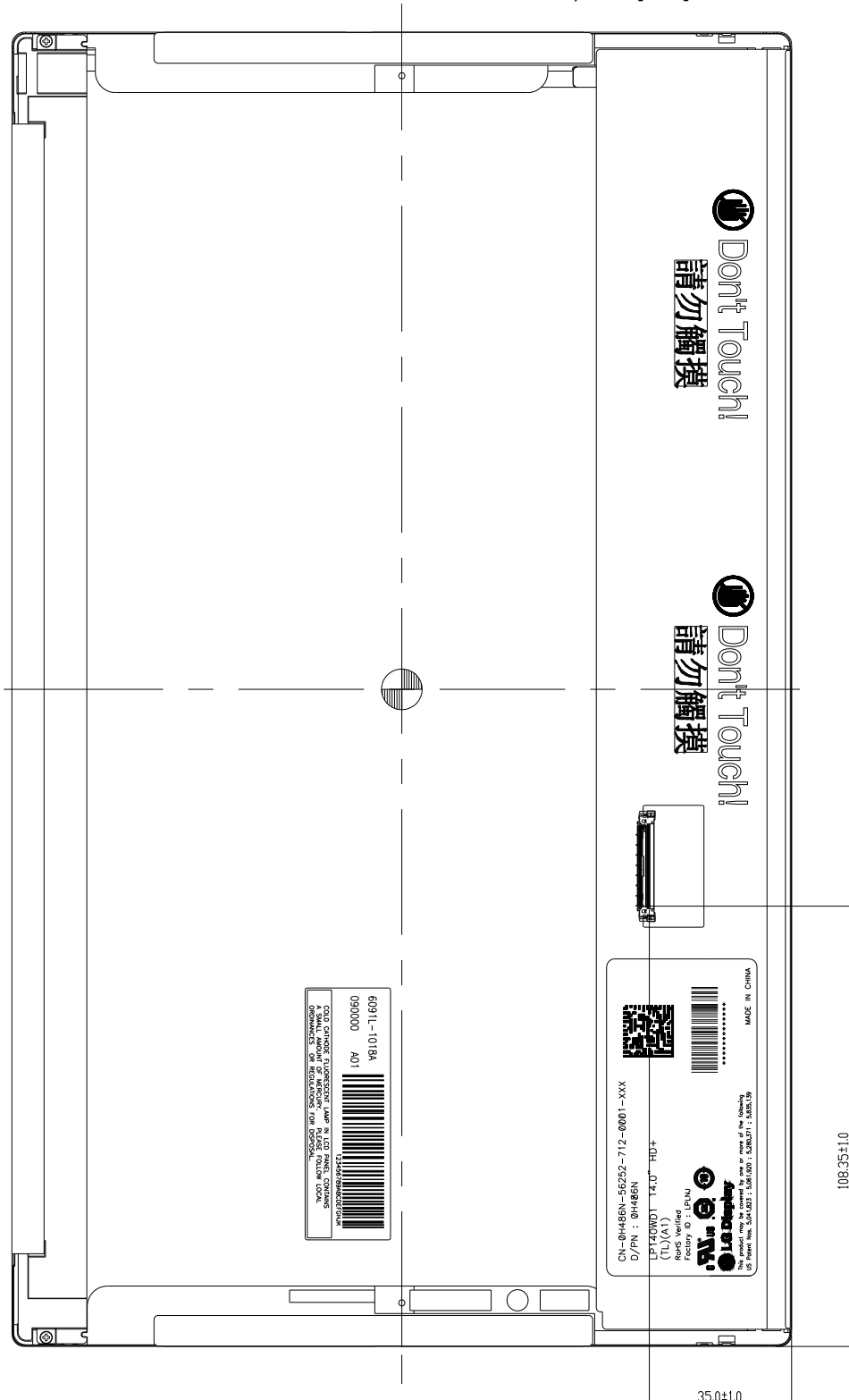
Product Specification
<FRONT VIEW>

 Note) Unit:[mm], General tolerance: $\pm 0.5\text{mm}$


Product Specification

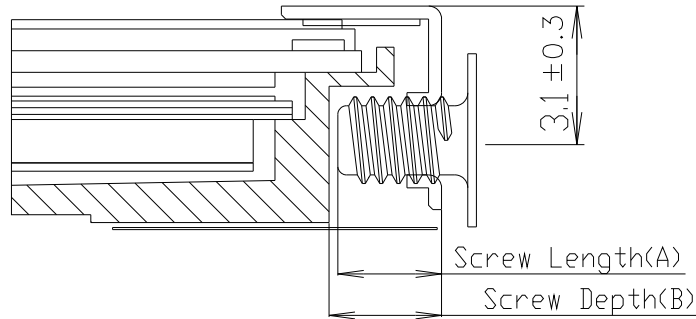
<REAR VIEW>

Note) Unit:[mm], General tolerance: $\pm 0.5\text{mm}$



Product Specification

[DETAIL DESCRIPTION OF SIDE MOUNTING SCREW]

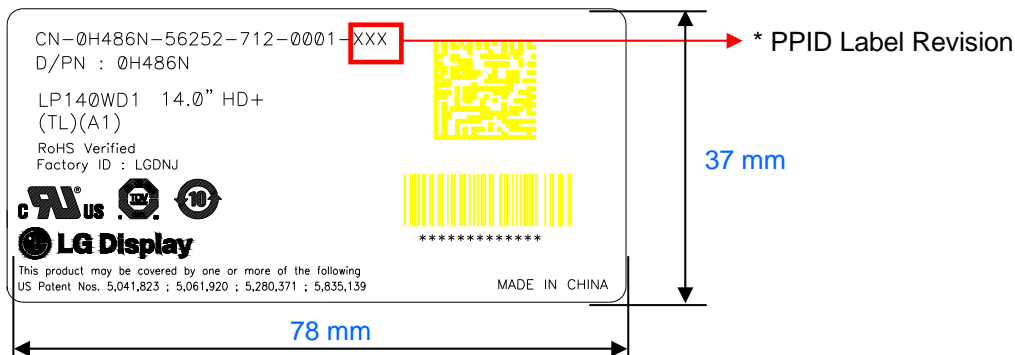


SECTION H-H
 SCALE 5/1

- * Mounting Screw Length (A)
 = 2.0(Min) / 2.5(Max)
- * Mounting Screw Hole Depth (B)
 = 2.5(Min)
- * Mounting hole location : 3.1(typ.)
- * Torque : 2.0 kgf.cm(Max)
 (Measurement gauge : torque meter)

Notes : 1. Screw plated through the method of non-electrolytic nickel plating is preferred to reduce possibility that results in vertical and/or horizontal line defect due to the conductive particles from screw surface.

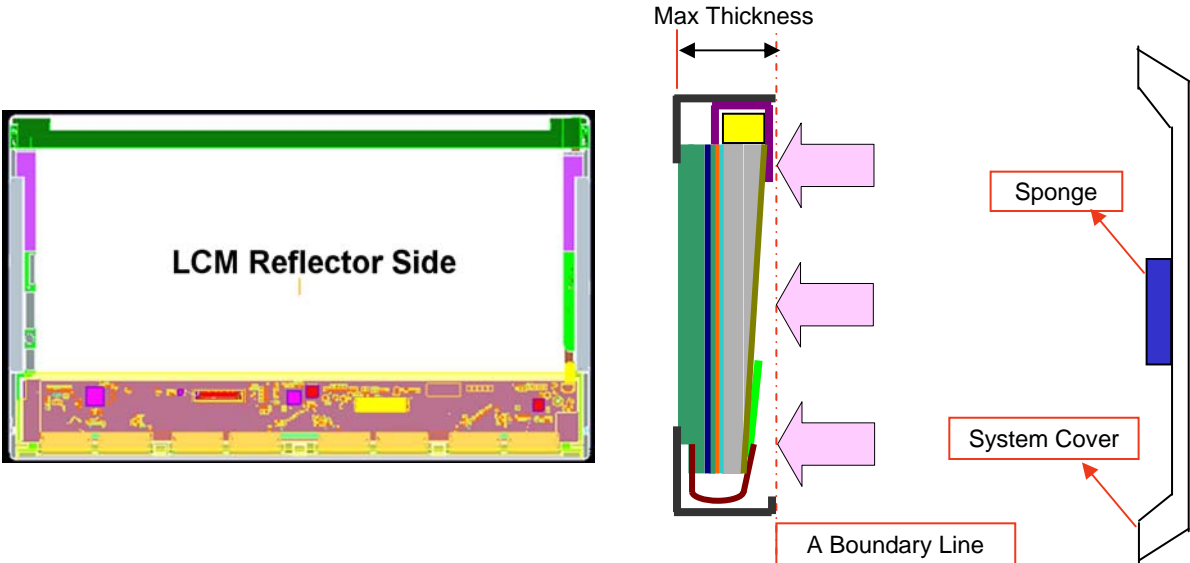
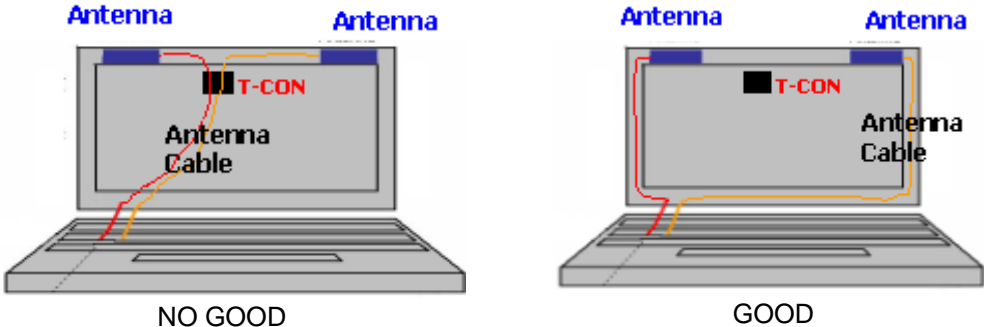
[DETAIL INFORMATION OF PPID LABEL AND REVISION CODE]



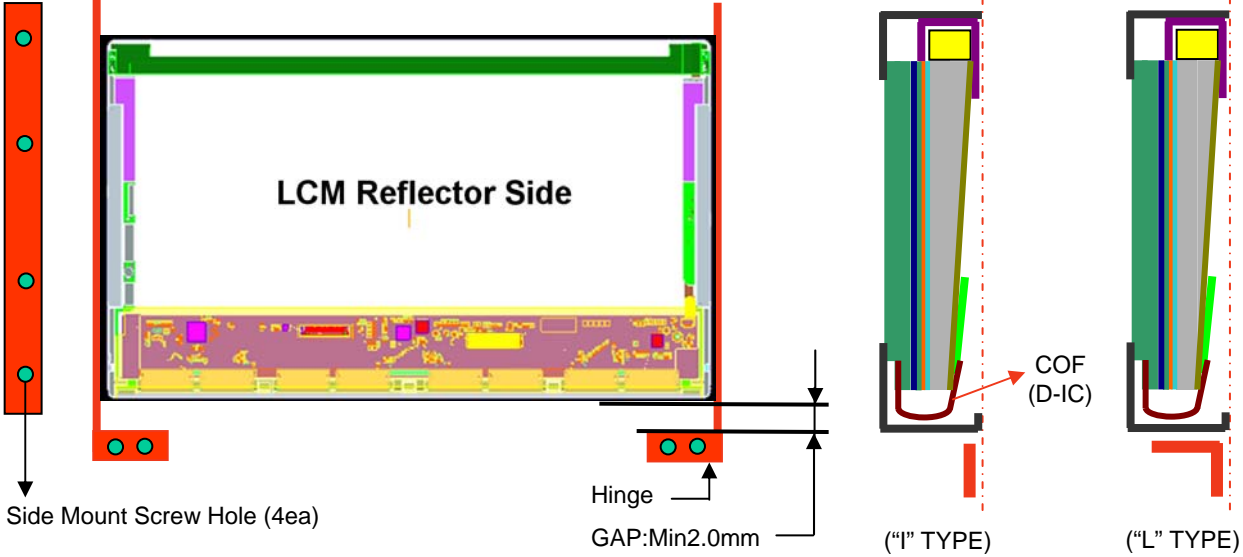
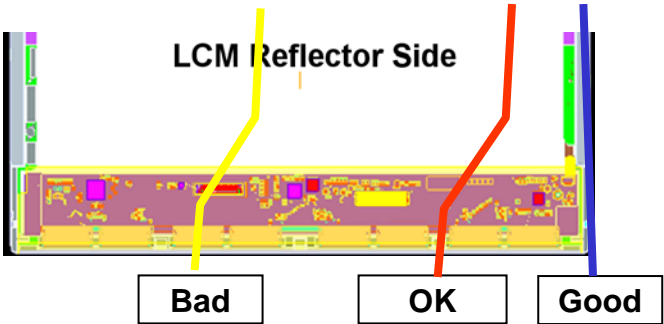
* PPID Label Revision :
 It is subject to change with Dell event. Please refer to the below table for detail.

Classification	No Change	1st Revision	2nd Revision	...	9th Revision	...
SST(WS)	X00	X01	X02	...	A09	...
PT(ES)	X10	X11	X12	...	A19	...
ST(CS)	X20	X21	X22	...	A29	...
XB(MP)	A00	A01	A02	...	A09	...


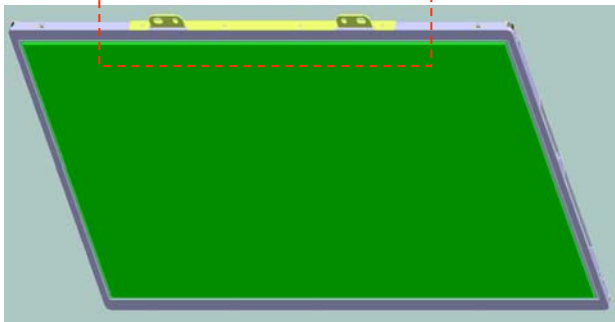
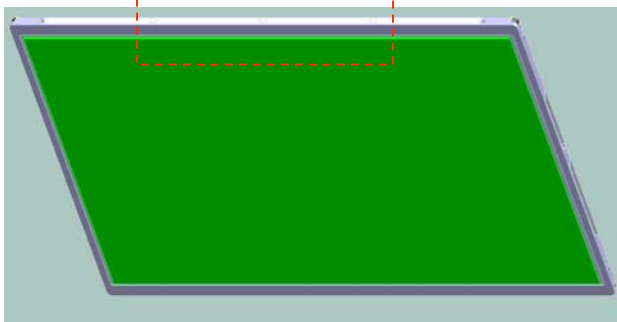
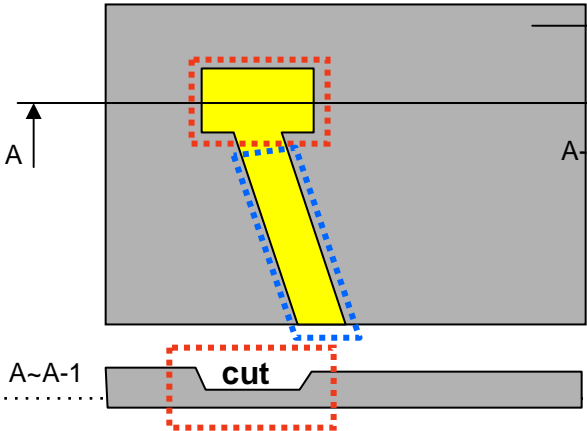


LGD Proposal for system cover design.(Appendix)

1	Gap check for securing the enough gap between LCM and System cover.	
		
Define	1.Rear side of LCM is sensitive against external stress,and previous check about interference is highly needed. 2.In case there is something from system cover comes into the boundary above,mechanical interference may cause the FOS defects. (Eg:Ripple,White spot..)	
2	Check if antenna cable is sufficiently apart from T-CON of LCD Module.	
Define		
	1.If system antenna is overlapped with T-CON,it might be cause the noise.	

LGD Proposal for system cover design.

3	Gap check for securing the enough gap between LCM and System hinge.	
	 <p>LCM Reflector Side</p> <p>Side Mount Screw Hole (4ea)</p> <p>Hinge</p> <p>GAP: Min2.0mm</p> <p>COF (D-IC)</p> <p>("I" TYPE)</p> <p>("L" TYPE)</p>	
Define	1. At least 2.0mm of gap needs to be secured to prevent the shock related defects. 2. "L" type of hinge is recommended than "I" type under shock test.	
4	Checking the path of the System wire.	
	 <p>LCM Reflector Side</p> <p>Bad</p> <p>OK</p> <p>Good</p>	
Define	1. COF area needs to be handled with care. 2. GOOD → Wire path design to system side. OK → Wire path is located between COFs. BAD → Wire path overlapped with COF area.	

LGD Proposal for system cover design.

5	Using a bracket on the top of LCM is not recommended.	
<div><div><p>bracket</p></div><div><div><p>With bracket</p></div><div><div><p>Without bracket</p></div></div></div></div>		
Define	<div>1.Condition without bracket is good for mechanical noise,and can minimize the light leakage from deformation of bracket.</div> <div>2.The results shows that there is no difference between the condition with or without bracket.</div>	
6	Securing additional gap on CNT area..	
<div><div><div></div><div><div>System cover inner side.</div><div><div></div><div>User connector area.</div><div><div></div><div>User connector Cable pathway.</div><div>FPC:Flexible Printed Circuit.</div></div></div></div></div></div>		
Define	<div>1.CNT area is specially sensitive against external stress,and additional gap by cutting on system cover will be helpful on removing the Ripple.</div> <div>2.Using a thinner CNT will be better. (eg: FPC type)</div>	

Product Specification

6. Reliability

Environment test condition

No.	Test Item	Conditions
1	High temperature storage test	Ta= 60°C, 240h
2	Low temperature storage test	Ta= -20°C, 240h
3	High temperature operation test	Ta= 50°C, 50%RH, 240h
4	Low temperature operation test	Ta= 0°C, 240h
5	Vibration test (non-operating)	Sine wave, 10 ~ 500 ~ 10Hz, 1.5G, 0.37oct/min 3 axis, 1hour/axis
6	Shock test (non-operating)	Half sine wave, 180G, 2ms one shock of each six faces(l.e. run 180G 2ms for all six faces)
7	Altitude operating storage / shipment	0 ~ 10,000 feet (3,048m) 24Hr 0 ~ 40,000 feet (12,192m) 24Hr

{ Result Evaluation Criteria }

There should be no change which might affect the practical display function when the display quality test is conducted under normal operating condition.

7. International Standards

7-1. Safety

- a) UL 60950-1:2003, First Edition, Underwriters Laboratories, Inc., Standard for Safety of Information Technology Equipment.
- b) CAN/CSA C22.2, No. 60950-1-03 1st Ed. April 1, 2003, Canadian Standards Association, Standard for Safety of Information Technology Equipment.
- c) EN 60950-1:2001, First Edition, European Committee for Electrotechnical Standardization(CENELEC) European Standard for Safety of Information Technology Equipment.

7-2. EMC

- a) ANSI C63.4 "Methods of Measurement of Radio-Noise Emissions from Low-Voltage Electrical and Electrical Equipment in the Range of 9kHz to 40GHz. "American National Standards Institute(ANSI), 1992
- b) C.I.S.P.R "Limits and Methods of Measurement of Radio Interface Characteristics of Information Technology Equipment." International Special Committee on Radio Interference.
- c) EN 55022 "Limits and Methods of Measurement of Radio Interface Characteristics of Information Technology Equipment." European Committee for Electrotechnical Standardization.(CENELEC), 1998 (Including A1: 2000)

Product Specification

8. Packing

8-1. Designation of Lot Mark

a) Lot Mark

A	B	C	D	E	F	G	H	I	J	K	L	M
---	---	---	---	---	---	---	---	---	---	---	---	---

A,B,C : SIZE(INCH)

E : MONTH

D : YEAR

F ~ M : SERIAL NO.

Note

1. YEAR

Year	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010
Mark	1	2	3	4	5	6	7	8	9	0

2. MONTH

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Mark	1	2	3	4	5	6	7	8	9	A	B	C

b) Location of Lot Mark

Serial No. is printed on the label. The label is attached to the backside of the LCD module.
This is subject to change without prior notice.

8-2. Packing Form

a) Package quantity in one box : 30 pcs

b) Box Size : 490mm X 390mm X 256 mm

9. PRECAUTIONS

Please pay attention to the followings when you use this TFT LCD module.

9-1. MOUNTING PRECAUTIONS

- (1) You must mount a module using holes arranged in four corners or four sides.
- (2) You should consider the mounting structure so that uneven force (ex. Twisted stress) is not applied to the module. And the case on which a module is mounted should have sufficient strength so that external force is not transmitted directly to the module.
- (3) Please attach the surface transparent protective plate to the surface in order to protect the polarizer. Transparent protective plate should have sufficient strength in order to resist external force.
- (4) You should adopt radiation structure to satisfy the temperature specification.
- (5) Acetic acid type and chlorine type materials for the cover case are not desirable because the former generates corrosive gas of attacking the polarizer at high temperature and the latter causes circuit break by electro-chemical reaction.
- (6) Do not touch, push or rub the exposed polarizers with glass, tweezers or anything harder than HB pencil lead. And please do not rub with dust clothes with chemical treatment. Do not touch the surface of polarizer for bare hand or greasy cloth. (Some cosmetics are detrimental to the polarizer.)
- (7) When the surface becomes dusty, please wipe gently with absorbent cotton or other soft materials like chamois soaked with petroleum benzene. Normal-hexane is recommended for cleaning the adhesives used to attach front / rear polarizers. Do not use acetone, toluene and alcohol because they cause chemical damage to the polarizer.
- (8) Wipe off saliva or water drops as soon as possible. Their long time contact with polarizer causes deformations and color fading.
- (9) Do not open the case because inside circuits do not have sufficient strength.

9-2. OPERATING PRECAUTIONS

- (1) The spike noise causes the mis-operation of circuits. It should be lower than following voltage :
 $V = \pm 200\text{mV}$ (Over and under shoot voltage)
- (2) Response time depends on the temperature. (In lower temperature, it becomes longer.)
- (3) Brightness depends on the temperature. (In lower temperature, it becomes lower.)
And in lower temperature, response time (required time that brightness is stable after turned on) becomes longer.
- (4) Be careful for condensation at sudden temperature change. Condensation makes damage to polarizer or electrical contacted parts. And after fading condensation, smear or spot will occur.
- (5) When fixed patterns are displayed for a long time, remnant image is likely to occur.
- (6) Module has high frequency circuits. Sufficient suppression to the electromagnetic interference shall be done by system manufacturers. Grounding and shielding methods may be important to minimize the interference.

9-3. ELECTROSTATIC DISCHARGE CONTROL

Since a module is composed of electronic circuits, it is not strong to electrostatic discharge. Make certain that treatment persons are connected to ground through wrist band etc. And don't touch interface pin directly.

9-4. PRECAUTIONS FOR STRONG LIGHT EXPOSURE

Strong light exposure causes degradation of polarizer and color filter.

9-5. STORAGE

When storing modules as spares for a long time, the following precautions are necessary.

- (1) Store them in a dark place. Do not expose the module to sunlight or fluorescent light. Keep the temperature between 5°C and 35°C at normal humidity.
- (2) The polarizer surface should not come in contact with any other object.
It is recommended that they be stored in the container in which they were shipped.

9-6. HANDLING PRECAUTIONS FOR PROTECTION FILM

- (1) When the protection film is peeled off, static electricity is generated between the film and polarizer.
This should be peeled off slowly and carefully by people who are electrically grounded and with well ion-blown equipment or in such a condition, etc.
- (2) The protection film is attached to the polarizer with a small amount of glue. If some stress is applied to rub the protection film against the polarizer during the time you peel off the film, the glue is apt to remain on the polarizer.
Please carefully peel off the protection film without rubbing it against the polarizer.
- (3) When the module with protection film attached is stored for a long time, sometimes there remains a very small amount of glue still on the polarizer after the protection film is peeled off.
- (4) You can remove the glue easily. When the glue remains on the polarizer surface or its vestige is recognized, please wipe them off with absorbent cotton waste or other soft material like chamois soaked with normal-hexane.

Product Specification
APPENDIX A. Enhanced Extended Display Identification Data (EEDID™) 1/3
EDID Data for Dell _ ver. 1.0

2009/5/12

	Byte (Dec)	Byte (Hex)	Field Name and Comments	Value (Hex)	Value (Bin)
Header	0	00	Header	00	00000000
	1	01	Header	FF	11111111
	2	02	Header	FF	11111111
	3	03	Header	FF	11111111
	4	04	Header	FF	11111111
	5	05	Header	FF	11111111
	6	06	Header	FF	11111111
Vendor / Product	7	07	Header	00	00000000
	8	08	EISA manufacture code (3 Character ID) LGD	30	00110000
	9	09	EISA manufacture code (Compressed ASC II)	E4	11100100
	10	0A	Panel Supplier Reserved - Product Code 0208h	08	00001000
	11	0B	(Hex. LSB first)	02	00000010
	12	0C	LCD Module Serial No - Preferred but Optional ("0" if not used)	00	00000000
	13	0D	LCD Module Serial No - Preferred but Optional ("0" if not used)	00	00000000
	14	0E	LCD Module Serial No - Preferred but Optional ("0" if not used)	00	00000000
	15	0F	LCD Module Serial No - Preferred but Optional ("0" if not used)	00	00000000
	16	10	Week of Manufacture 00 weeks	00	00000000
Display	17	11	Year of Manufacture 2009 years	13	00010011
	18	12	EDID structure version # = 1	01	00000001
	19	13	EDID revision # = 3	03	00000011
	20	14	Video input Definition = Digital signal, 6 bit _ Dell only	90	10010000
	21	15	Max H image size (Rounded cm) = 31 cm	1F	00011111
	22	16	Max V image size (Rounded cm) = 17 cm	11	00010001
	23	17	Display gamma = (gamma*100)-100 = Example (2.2*100)-100=120 = 2.2 Gamma	78	01111000
Vendor / Product	24	18	Feature Support (no_DPMS, no_Active Off/Very Low Power, RGB color display, Timing BLK 1, no_GTF)	0A	00001010
	25	19	Red/Green Low Bits (RxRy/GxGy)	9B	10011011
	26	1A	Blue/White Low Bits (BxBY/WxWy)	65	01100101
	27	1B	Red X Rx = 0.604	9A	10011010
	28	1C	Red Y Ry = 0.356	5B	01011011
	29	1D	Green X Gx = 0.326	53	01010011
	30	1E	Green Y Gy = 0.581	94	10010100
	31	1F	Blue X Bx = 0.149	26	00100110
	32	20	Blue Y By = 0.053	0D	00001101
	33	21	White X Wx = 0.313	50	01010000
Established	34	22	White Y Wy = 0.329	54	01010100
	35	23	Established timing 1 (00h if not used)	00	00000000
	36	24	Established timing 2 (00h if not used)	00	00000000
Standard Timing ID	37	25	Manufacturer's timings (00h if not used)	00	00000000
	38	26	Standard timing ID1 (01h if not used)	01	00000001
	39	27	Standard timing ID1 (01h if not used)	01	00000001
	40	28	Standard timing ID2 (01h if not used)	01	00000001
	41	29	Standard timing ID2 (01h if not used)	01	00000001
	42	2A	Standard timing ID3 (01h if not used)	01	00000001
	43	2B	Standard timing ID3 (01h if not used)	01	00000001
	44	2C	Standard timing ID4 (01h if not used)	01	00000001
	45	2D	Standard timing ID4 (01h if not used)	01	00000001
	46	2E	Standard timing ID5 (01h if not used)	01	00000001
	47	2F	Standard timing ID5 (01h if not used)	01	00000001
	48	30	Standard timing ID6 (01h if not used)	01	00000001
	49	31	Standard timing ID6 (01h if not used)	01	00000001
	50	32	Standard timing ID7 (01h if not used)	01	00000001
	51	33	Standard timing ID7 (01h if not used)	01	00000001
	52	34	Standard timing ID8 (01h if not used)	01	00000001
	53	35	Standard timing ID8 (01h if not used)	01	00000001

Product Specification
APPENDIX A. Enhanced Extended Display Identification Data (EEDID™) 2/3

	Byte (Dec)	Byte (Hex)	Field Name and Comments	Value (Hex)	Value (Bin)
Timing Descriptor #1	54	36	Pixel Clock/10,000 (LSE) 101.34 MHz @ 60Hz	96	10010110
	55	37	Pixel Clock/10,000 (MSB)	27	00100111
	56	38	Horizontal Active (lower 8 bits) 1600 Pixels	40	01000000
	57	39	Horizontal Blanking(Thp-HA) (lower 8 bits) 224 Pixels	E0	11100000
	58	3A	Horizontal Active / Horizontal Blanking(Thp-HA) (upper 4.4bits)	60	01100000
	59	3B	Vertical Active 900 Lines	84	10000100
	60	3C	Vertical Blanking (Tvp-HA) (DE Blanking typ for DE only panels) 26 Lines	1A	00011010
	61	3D	Vertical Active : Vertical Blanking (Tvp-HA) (upper 4.4bits)	30	00110000
	62	3E	Horizontal Sync. Offset (Thfp) 32 Pixels	20	00100000
	63	3F	Horizontal Sync Pulse Width (HSPW) 48 Pixels	30	00110000
	64	40	Vertical Sync Offset(Tvfp) : Sync Width (VSPW) 3 Lines : 5 Lines	35	00110101
	65	41	Horizontal Vertical Sync Offset/Width (upper 2bits)	00	00000000
	66	42	Horizontal Image Size (mm) 310 mm	36	00110110
	67	43	Vertical Image Size (mm) 174 mm	AE	10101110
	68	44	Horizontal Image Size / Vertical Image Size	10	00010000
	69	45	Horizontal Border = 0 (Zero for Notebook LCD)	00	00000000
	70	46	Vertical Border = 0 (Zero for Notebook LCD)	00	00000000
	71	47	Non-Interlace, Normal display, no stereo, Digital Separate (Vsync_NEG, Hsync_POS), DE only note : LSB is set to '1' if panel is DE-timing only. H/V can be ignored.	1B	00011011
Timing Descriptor #2	72	48	Pixel Clock/10,000 (LSE) 101.34 MHz @ 60Hz	96	10010110
	73	49	Pixel Clock/10,000 (MSB)	27	00100111
	74	4A	Horizontal Active (lower 8 bits) 1600 Pixels	40	01000000
	75	4B	Horizontal Blanking(Thp-HA) (lower 8 bits) 224 Pixels	E0	11100000
	76	4C	Horizontal Active / Horizontal Blanking(Thp-HA) (upper 4.4bits)	60	01100000
	77	4D	Vertical Active 900 Lines	84	10000100
	78	4E	Vertical Blanking (Tvp-HA) (DE Blanking typ for DE only panels) 26 Lines	1A	00011010
	79	4F	Vertical Active : Vertical Blanking (Tvp-HA) (upper 4.4bits)	30	00110000
	80	50	Horizontal Sync. Offset (Thfp) 32 Pixels	20	00100000
	81	51	Horizontal Sync Pulse Width (HSPW) 48 Pixels	30	00110000
	82	52	Vertical Sync Offset(Tvfp) : Sync Width (VSPW) 3 Lines : 5 Lines	35	00110101
	83	53	Horizontal Vertical Sync Offset/Width (upper 2bits)	00	00000000
	84	54	Horizontal Image Size (mm) 310 mm	36	00110110
	85	55	Vertical Image Size (mm) 174 mm	AE	10101110
	86	56	Horizontal Image Size / Vertical Image Size	10	00010000
	87	57	Horizontal Border = 0 (Zero for Notebook LCD)	00	00000000
	88	58	Vertical Border = 0 (Zero for Notebook LCD)	00	00000000
	89	59	Non-Interlace, Normal display, no stereo, Digital Separate (Vsync_NEG, Hsync_POS), DE only note : LSB is set to '1' if panel is DE-timing only. H/V can be ignored.	1B	00011011
Timing Descriptor #3	90	5A	Flag	00	00000000
	91	5B	Flag	00	00000000
	92	5C	Flag	00	00000000
	93	5D	Data Type Tag : Alphanumeric Data String (ASCII String)	FE	11111110
	94	5E	Flag	00	00000000
	95	5F	Dell P/N 1st Character = H	48	01001000
	96	60	Dell P/N 2nd Character = 4	34	00110100
	97	61	Dell P/N 3rd Character = 8	38	00111000
	98	62	Dell P/N 4th Character = 6	36	00110110
	99	63	Dell P/N 5th Character = N	4E	01001110
	100	64	EDID Revision Build Name = MP(X-Build) , Revision # = A00	80	10000000
	101	65	Manufacturer P/N = 1	31	00110001
	102	66	Manufacturer P/N = 4	34	00110100
	103	67	Manufacturer P/N = 0	30	00110000
	104	68	Manufacturer P/N = W	57	01010111
	105	69	Manufacturer P/N = D	44	01000100
	106	6A	Manufacturer P/N = 1	31	00110001
	107	6B	Manufacturer P/N(If<13 char-> 0Ah, then terminate with ASCII code 0Ah, set remaining char = 20h)	0A	00001010

Product Specification

APPENDIX A. Enhanced Extended Display Identification Data (EEDID™) 3/3

	Byte (Dec)	Byte (Hex)	Field Name and Comments	Value (Hex)	Value (Bin)
Timing Descriptor #4	108	6C	Flag	00	00000000
	109	6D	Flag	00	00000000
	110	6E	Flag	00	00000000
	111	6F	Data Type Tag : Descriptor Defined by manufacturer	00	00000000
	112	70	Flag	00	00000000
	113	71	SMBUS Value(Step #1) = 10 nits	1D	00011101
	114	72	SMBUS Value(Step #2) = 17 nits	2D	00101101
	115	73	SMBUS Value(Step #3) = 24 nits	39	00111001
	116	74	SMBUS Value(Step #4) = 30 nits	45	01000101
	117	75	SMBUS Value(Step #5) = 60 nits	6F	01101111
	118	76	SMBUS Value(Step #6) = 100 nits	97	10010111
	119	77	SMBUS Value(Step #7) = 160 nits	B7	10110111
	120	78	SMBUS Value(Step #8) = 220 nits (Typically = FFh, Max nits)	FB	11111011
	121	79	Dual LVDS, No RTC, No VIC support	02	00000010
	122	7A	BIST support	01	00000001
	123	7B	(If <13 char-> 0Ah, then terminate with ASC II code 0Ah, set remaining char = 20h)	0A	00001010
Checksum	124	7C	(If <13 char-> 0Ah, then terminate with ASC II code 0Ah, set remaining char = 20h)	20	00100000
	125	7D	(If <13 char-> 0Ah, then terminate with ASC II code 0Ah, set remaining char = 20h)	20	00100000
	126	7E	Extension flag (# of optional 128 panel ID extension block to follow, Typ = 0)	00	00000000
	127	7F	Check Sum (The 1-byte sum of all 128 bytes in this panel ID block shall = 0)	A0	10100000